POWER RELAY 1 POLE—8 A (MEDIUM LOAD CONTROL)

JS SERIES

Lead Free / RoHS compliant*

FEATURES

- UL, CSA, VDE, SEV, SEMKO, FIMKO, ÖVE, BSI recognized
- UL class B (130°C) insulation
- 1 form A (SPST-NO) or 1 form C (SPDT) contact
- Low profile and space saving—Height: 12.5 mm
- -Mounting space: 290 mm²
- High sensitivity in small package
 —Operating power 0.11 to 0.14 W
 —Nominal power 0.22 to 0.29 W
- High isolation in small package

 Insulation distance : 8 mm
 Dielectric strength : 5,000 VAC (between coil and contacts)
 Surge strength : 10,000 V
- Plastic materials—UL 94 flame class V-0 —UL CTI level class 2



- Plastic sealed type
- Lead Free since date code: 0438B9, 0434R Please see page 6 for more information
- * some part numbers still contain cadmium and are not RoHS compliant

ORDERING INFORMATION

[Example]

 $\frac{JS}{(a)} \xrightarrow{-} \frac{12}{(b)} \xrightarrow{M} \frac{E}{(c)} \xrightarrow{-} \frac{K}{(e)} \xrightarrow{T} \xrightarrow{-} \frac{V3}{(i)}$

	(a) (*) (b) (c) (u)	
(a)	Series Name	JS : JS Series
(b)	Nominal Voltage	Refer to the COIL DATA CHART
(c)	Contact Arrangement	Nil : 1 form C (SPDT) M : 1 form A (SPST-NO)
(d)	Contact Material	Nil : Gold plate silver cadmium oxide D : Silver nickel E : Silver cadmium oxide F : Silver nickel gold overlay N : Silver tin oxide gold overlay
(e)	Enclosure	K : Plastic sealed type
(f)	Construction	Nil: 3.2 mm T : 5.0 mm (only JS-MN, MD, MF)
(j)	For low current application	Nil: 0.3 μ gold overlay (available with Nil, N and F contact) V3: 3 μ gold overlay for lower current applications (available with Nil, N and F contact)

■ SAFETY STANDARD AND FILE NUMBERS

UL508, 873 (File No. E56140, E108658) C22.2 No. 14 (File No. LR35579) VDE 0435, 0631, 0700 (File No. 11039-4940-1010)

Nominal voltage	Contact rating
5 to 60 VDC	1/3 HP 125 VAC, 1/2 HP 250 VAC 10 A 30 VDC/250 VAC, resistive 3A 250 VAC inductive (PF = 0.4) Pilot duty B 300, C150

■ SPECIFICATIONS

1 - Contact material Silver Cadmium Oxide (AgCdO) type: Nil, E type

Item			JS ()-K	JS ()E-K	JS ()M-K	JS ()ME-K	
	Arrangement		1 Form C (SPDT) 1 Form A (SPST-NO)			PST-NO)	
	Material		Au+AgCdO	AgCdO	Au+AgCdO	AgCdO	
	Resistance (initial)		30m Ohms (Au 3µm), 100m Ohms (Au 0.3µm) 1A 6 VDC				
	Rating		8A 250 VAC / 24 VDC				
Contact	Max. carrying current		10A				
	Max. switching power		2,000VA/192W				
	Max. switching voltage		150VDC/400VAC				
	Min. switching load		10mA 5VDC				
	Max. switching current		10A				
Coil	Operating temperature		-40° C to +85° C (no frost)				
Time value	Operate		Max. 10ms (at nominal voltage, without bounce)				
	Release (without diode)		Max. 5ms (at nominal voltage, without bounce)				
	Resistance (at 500VDC)		Min. 1,000 Mohms				
Insulation	Dielectric Strength	B/T contacts	1,000VAC, 1 minute				
Insulation		B/T coil and contacts	4,000VAC, 1 minute				
	Surge strength		10,000V (at1.2x50 µsec.)				
Life	Mechanical		20x10 ⁶ operations minimum				
LIIE	Electrical (resistive load)		100x10 ³ operations min.				
Vibration	Misoperation		10 to 55 Hz at double amplitude of 1.65mm				
resistance	Endurance		10 to 55 Hz at double amplitude of 3.3mm				
Shock	Misoperation		Min. 200m/s ² (11±1ms)				
resistance	Endurance		Min. 1,000m/s² (6±1ms)				
Weight		Approx. 8g					

Item			JS ()N-K	JS ()MN-K	JS ()MN-KT		
	Arrangement		1 Form C	1 Form A			
	Material		Au+AgSnO ₂				
	Resistance (initial)		Max. 100 mohm	Max. 100 mohms (at 1A 6 VDC)			
	Rating		8A 250 VAC / 24 VDC				
Contact	Max. carryi	ng current	10A				
	Max. switch	ning power	2,000VA/192W				
	Max. switching voltage		150VDC/400VAC				
	Min. switching load		10mA 5VDC				
	Max. switching current		10A				
Coil	Operating t	emperature	-40° C to +85° C (no frost)				
Time value	Operate		Max. 10ms (at nominal voltage, without bounce)				
	Release (without diode)		Max. 5ms (at nominal voltage, without bounce)				
	Resistance (at 500VDC)		Min. 1,000 Mohms				
la sulstian	Dielectric Strength	B/T contacts	1,000VAC, 1 minute				
Insulation		B/T coil and contacts	4,000VAC, 1 minute				
	Surge strength		10,000V (at1.2x50 µsec.)				
	Mechanical		20x10 ⁶ operations minimum				
Life	Electrical (resistive load)		50x10 ³ ops. min.	100x10 ³ ops.	min.		
Vibration	Misoperation		10 to 55 Hz at double amplitude of 1.65mm				
resistance	Endurance		10 to 55 Hz at double amplitude of 3.3mm				
Shock	Misoperation		Min. 200m/s ² (11±1ms)				
resistance	Endurance		Min. 1,000m/s² (6±1ms)				
Weight			Approx. 8g				

Item			JS ()F-K	JS ()D-K	JS()MF-K JS()MF-KT	JS ()MD-K JS ()MD-KT		
	Arrangement		1 Form C		1 Form A			
	Material		Au+AgNi	AgNi	Au+AgNi	AgNi		
	Resistance (initial)		30m Ohms (Au 3µm), 100m Ohms (Au 0.3µm) 1A 6 VDC					
	Rating		8A 250 VAC / 24 VDC					
Contact	Max. carrying current		10A	10A				
	Max. switching power		2,000VA/192	2W				
	Max. switching voltage		150VDC/400	150VDC/400VAC				
	Min. switching load		10mA 5VDC					
	Max. switching current		10A					
Coil	Operating temperature		-40° C to +85° C (no frost)					
Time value	Operate		Max. 10ms (at nominal voltage, without bounce)					
Time value	Release (without diode)		Max. 5ms (at nominal voltage, without bounce)					
	Resistance (at 500VDC)		Min. 1,000 Mohms					
Insulation	Dielectric	Dielectric B/T contacts		1,000VAC, 1 minute				
Insulation	Strength	B/T coil and contacts	4,000VAC, 1 minute					
	Surge strength		10,000V (at1.2x50 µsec.)					
Life	Mechanical		20x10 ⁶ operations minimum					
LIIE	Electrical (resistive load)		20x10 ³ operations min.					
Vibration	Misoperation		10 to 55 Hz at double amplitude of 1.65mm					
resistance	Endurance		10 to 55 Hz at double amplitude of 3.3mm					
Shock	Misoperation		Min. 200m/s² (11±1ms)					
resistance	Endurance		Min. 1,000m/s² (6±1ms)					
Weight		Approx. 8g						

*1 Minimum switching loads mentioned above are reference values. Please perform the confirmation test with the actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

■ COIL DATA CHART

MODEL	Nominal voltage	Coil resistance (±10%)	Must operate voltage	Must release voltage	Nominal power
JS- 5(M)(NIL,E,N,D,F)-K(T)	5 VDC	112Ω	3.5 VDC	0.5 VDC	225 mW
JS- 6(M)(NIL,E,N,D,F)-K(T)	6 VDC	160Ω	4.2 VDC	0.6 VDC	225 mW
JS- 9(M)(NIL,E,N,D,F)-K(T)	9 VDC	360Ω	6.3 VDC	0.9 VDC	225 mW
JS-12(M)(NIL,E,N,D,F)-K(T)	12 VDC	660Ω	8.5 VDC	1.2 VDC	220 mW
JS-18(M)(NIL,E,N,D,F)-K(T)	18 VDC	1,455Ω	12.7 VDC	1.8 VDC	225 mW
JS-24(M)(NIL,E,N,D,F)-K(T)	24 VDC	2,350Ω	16.8 VDC	2.4 VDC	245 mW
JS-48(M)(NIL,E,N,D,F)-K(T)	48 VDC	8,000Ω	33.4 VDC	4.8 VDC	290 mW
JS-60(M)(NIL,E,N,D,F)-K(T)	60 VDC	12,500Ω	41.7 VDC	6.0 VDC	290 mW

Note : All values in the table are measured at 20° C.

■ CHARACTERISTIC DATA















Maximum Switching Power



■ REFERENCE DATA









Distribution of Contact Resistance

JS-12E-K -n=30

- ZZ Make

Distribution (%)







Contact Resistance (m Ω)

■ DIMENSIONS



RoHS Compliance and Lead Free Relay Information 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free • now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (http://www.fcai.fujitsu.com/pdf/LeadFreeLetter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu. From February 2005 forward Sn-3.0Cu-Ni will be used for FTRB3 and FTR-B4 series relays.
- Most signal and some power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 6 hazardous materials that are restricted by RoHS directive (lead, mercury, cadmium, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any • problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.

We will ship leaded relays as long as the leaded relay inventory exists.

2. Recommended Lead Free Solder Profile

 Recommended solder paste Sn-3.0Aq-0.5Cu and Sn-3.0 Cu-Ni (only FTR-B3 and FTR-B4 from February 2005) **Reflow Solder condtion**



We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

Moisture Sensitivity Level standard is not applicable to electromechanical realys.

4. Tin Whisker

SnAgCu solder is known as low riskof tin whisker. No considerable length whisker was found by our in-house test.

5. Solid State Relays

Each lead terminal will be changed from solder plating to Sn plating and Nickel plating. A layer of Nickel plating is between the terminal and the Sn plating to avoid whisker.

JS SERIES

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